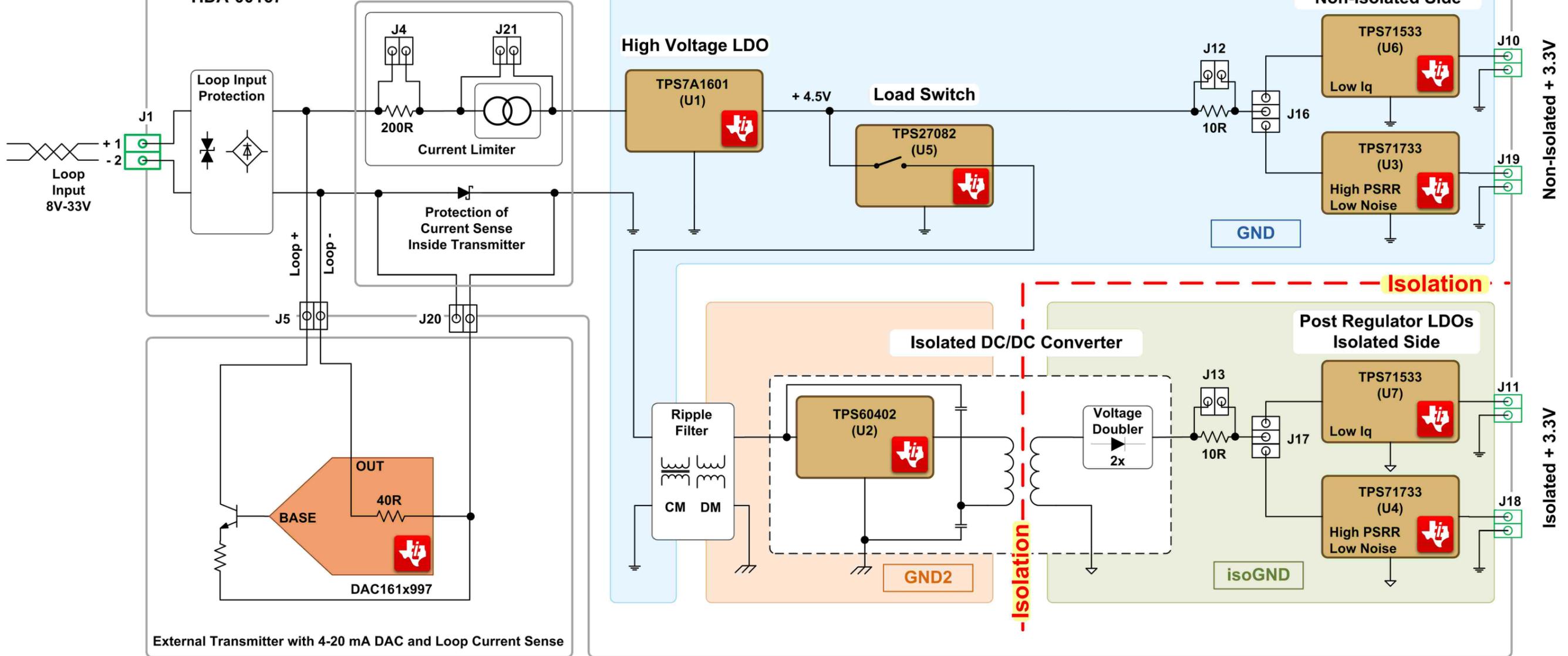




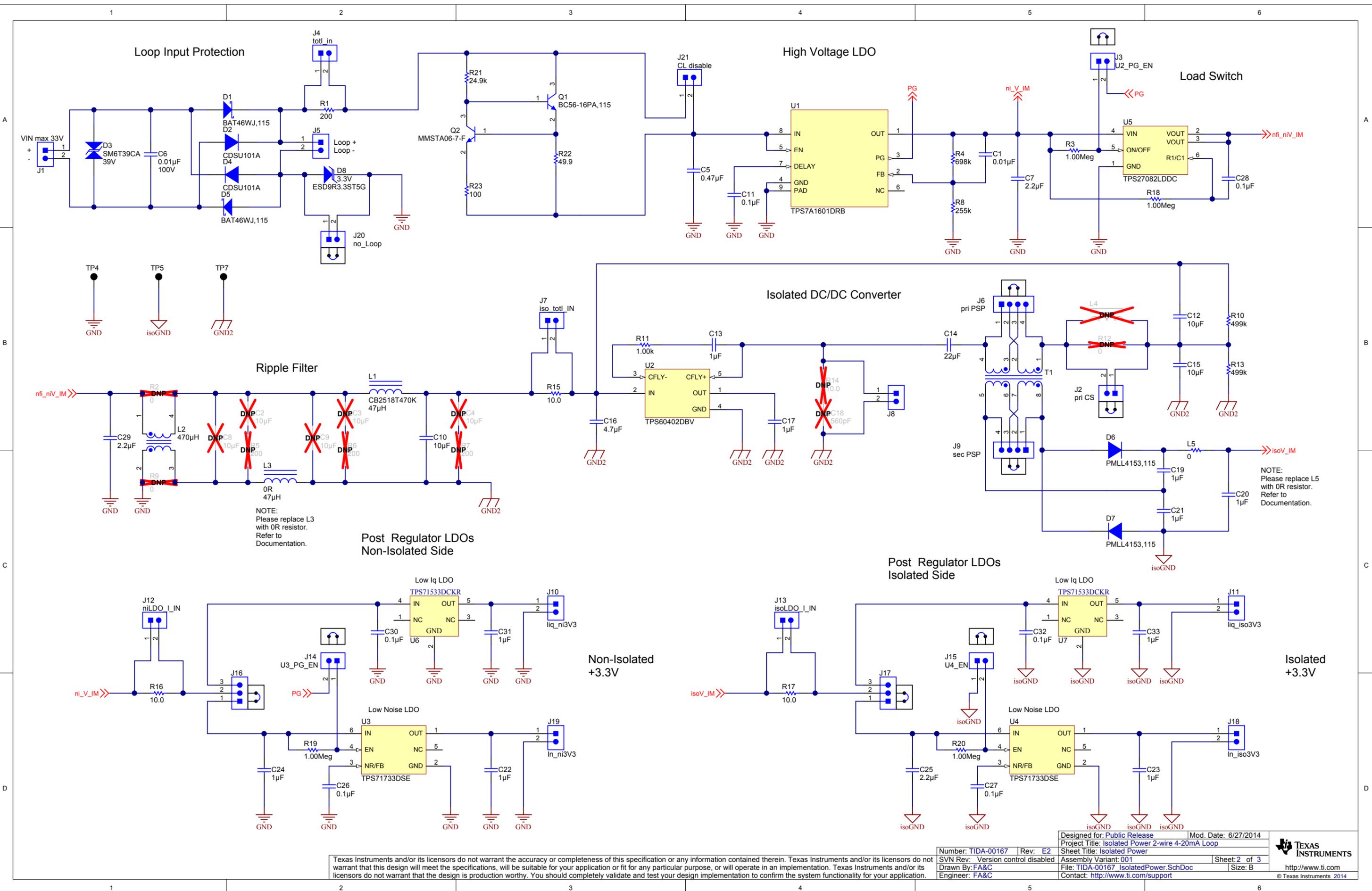
# Isolated Power Supply for 4-20mA loop powered Sensor Transmitters TIDA-00167



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Number: TIDA-00167	Rev: E2	Designed for: Public Release	Mod. Date: 7/31/2014
SVN Rev: Version control disabled	Assembly Variant: 001	Project Title: Isolated Power 2-wire 4-20mA Loop	Sheet: 1 of 3
Drawn By:	Engineer: FA&C	File: TIDA-00167_Cover.SchDoc	Size: B
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H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

~~DNP~~ FID1 ~~DNP~~ FID2 ~~DNP~~ FID3

PCB Number: TIDA-00167  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments

Label Table	
Variant	Label Text
001	001

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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SVN Rev: Version control disabled	Drawn By:	Project Title: Isolated Power 2-wire 4-20mA Loop	Sheet Title:
Engineer: FA&C	File: TIDA-00167_Hardware.SchDoc	Assembly Variant: 001	Sheet: 3 of 3
	Contact: http://www.ti.com/support		Size: B

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